Switching Diodes

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Unit: mm

MA6X122 (MA122)

Silicon epitaxial planar type

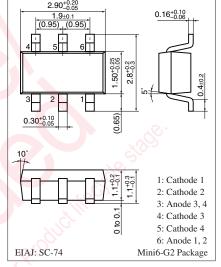
For switching circuit

Features

- Four isolated elements contained in one package, allowing highdensity mounting
- Centrosymmetrical wiring, allowing to free from the taping direction

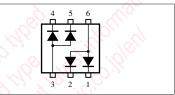
Symbol	Rating	Unit				
VR	80	v				
V _{RM}	80	V				
I _F	100	mA				
I _{FM}	225	mA				
I _{FSM}	500	mA				
Tj	150	°C				
T _{stg}	-55 to +150	°C				
	Symbol V _R V _{RM} I _F I _{FM} I _{FSM} T _j	$\begin{tabular}{ c c c c c } \hline Symbol & Rating \\ \hline V_R & 80 \\ \hline V_{RM} & 80 \\ \hline I_F & 100 \\ \hline I_{FM} & 225 \\ \hline I_{FSM} & 500 \\ \hline T_j & 150 \\ \hline \end{tabular}$				

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: M2A

Internal Connection



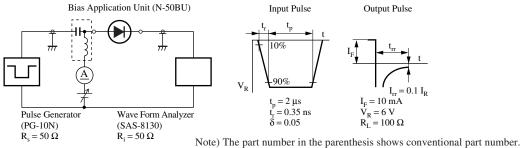
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	I _F = 100 mA	$\sqrt{2}$		1.2	V
Reverse voltage	V _R	$I_R = 100 \ \mu A$	80			V
Reverse current	I _R	V _R = 75 V			100	nA
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$			15	pF
Reverse recovery time *	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			10	ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

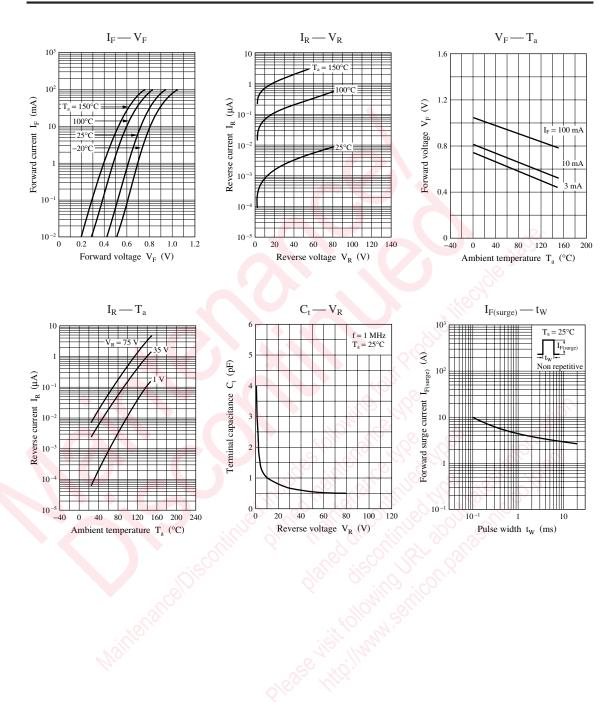
- 2. Absolute frequency of input and output is 100 MHz.
- 3. *: t_{rr} measurement circuit

Note) *1: Value for single diode *2: t = 1 s



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